

Semiconductor Manufacturing Back-End Equipment Market – Global Industry Size, Share, Trends, Opportunity, and Forecast Segmented By Type (Wafer Testing, Dicing, Bonding, Metrology, Assembly and Packaging), By Dimension (2D, 2.5D, 3D), By Supply Chain (Integrated Device Manufacturer, Outsourced Semiconductor Assembly and Test, Foundry), Region, By Competition, 2018-2028

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Abstracts

ing disposable incomes, and changing consumer preferences. The rapid pace of innovation in consumer electronics, with the introduction of new features, higher performance requirements, and the need f"

Contents

1. SERVICE OVERVIEW

- 1.1. Market Definition
- 1.2. Scope of the Market
 - 1.2.1. Markets Covered
 - 1.2.2. Years Considered for Study
 - 1.2.3. Key Market Segmentations

2. RESEARCH METHODOLOGY

- 2.1. Objective of the Study
- 2.2. Baseline Methodology
- 2.3. Formulation of the Scope
- 2.4. Assumptions and Limitations
- 2.5. Sources of Research
 - 2.5.1. Secondary Research
 - 2.5.2. Primary Research
- 2.6. Approach for the Market Study
 - 2.6.1. The Bottom-Up Approach
 - 2.6.2. The Top-Down Approach
- 2.7. Methodology Followed for Calculation of Market Size & Market Shares
- 2.8. Forecasting Methodology
 - 2.8.1. Data Triangulation & Validation

3. EXECUTIVE SUMMARY

4. VOICE OF CUSTOMER

5. GLOBAL SEMICONDUCTOR MANUFACTURING BACK-END EQUIPMENT MARKET OVERVIEW

6. GLOBAL SEMICONDUCTOR MANUFACTURING BACK-END EQUIPMENT MARKET OUTLOOK

6.1. Market Size & Forecast

6.1.1. By Value

6.2. Market Share & Forecast

6.2.1. By Type (Wafer Testing, Dicing, Bonding, Metrology, Assembly and Packaging)

6.2.2. By Dimension (2D, 2.5D, 3D)

6.2.3. By Supply Chain (Integrated Device Manufacturer, Outsourced Semiconductor Assembly and Test, Foundry, IT & Telecom, and Bonding)

6.2.4. By Region

6.3. By Company (2022)

6.4. Market Map

7. NORTH AMERICA SEMICONDUCTOR MANUFACTURING BACK-END EQUIPMENT MARKET OUTLOOK

7.1. Market Size & Forecast

7.1.1. By Value

7.2. Market Share & Forecast

7.2.1. By Type

7.2.2. By Dimension

7.2.3. By Supply Chain

7.2.4. By Country

7.3. North America: Country Analysis

7.3.1. United States Semiconductor Manufacturing Back-End Equipment Market Outlook

7.3.1.1. Market Size & Forecast

7.3.1.1.1. By Value

7.3.1.2. Market Share & Forecast

7.3.1.2.1. By Type

7.3.1.2.2. By Dimension

7.3.1.2.3. By Supply Chain

7.3.2. Canada Semiconductor Manufacturing Back-End Equipment Market Outlook

7.3.2.1. Market Size & Forecast

7.3.2.1.1. By Value

7.3.2.2. Market Share & Forecast

7.3.2.2.1. By Type

7.3.2.2.2. By Dimension

7.3.2.2.3. By Supply Chain

7.3.3. Mexico Semiconductor Manufacturing Back-End Equipment Market Outlook

7.3.3.1. Market Size & Forecast

- 7.3.3.1.1. By Value
- 7.3.3.2. Market Share & Forecast
 - 7.3.3.2.1. By Type
 - 7.3.3.2.2. By Dimension
 - 7.3.3.2.3. By Supply Chain

8. EUROPE SEMICONDUCTOR MANUFACTURING BACK-END EQUIPMENT MARKET OUTLOOK

- 8.1. Market Size & Forecast
 - 8.1.1. By Value
- 8.2. Market Share & Forecast
 - 8.2.1. By Type
 - 8.2.2. By Dimension
 - 8.2.3. By Supply Chain
 - 8.2.4. By Country
- 8.3. Europe: Country Analysis
 - 8.3.1. Germany Semiconductor Manufacturing Back-End Equipment Market Outlook
 - 8.3.1.1. Market Size & Forecast
 - 8.3.1.1.1. By Value
 - 8.3.1.2. Market Share & Forecast
 - 8.3.1.2.1. By Type
 - 8.3.1.2.2. By Dimension
 - 8.3.1.2.3. By Supply Chain
 - 8.3.2. United Kingdom Semiconductor Manufacturing Back-End Equipment Market Outlook
 - 8.3.2.1. Market Size & Forecast
 - 8.3.2.1.1. By Value
 - 8.3.2.2. Market Share & Forecast
 - 8.3.2.2.1. By Type
 - 8.3.2.2.2. By Dimension
 - 8.3.2.2.3. By Supply Chain
 - 8.3.3. Italy Semiconductor Manufacturing Back-End Equipment Market Outlook
 - 8.3.3.1. Market Size & Forecast
 - 8.3.3.1.1. By Value
 - 8.3.3.2. Market Share & Forecasty
 - 8.3.3.2.1. By Type
 - 8.3.3.2.2. By Dimension
 - 8.3.3.2.3. By Supply Chain

8.3.4. France Semiconductor Manufacturing Back-End Equipment Market Outlook

8.3.4.1. Market Size & Forecast

8.3.4.1.1. By Value

8.3.4.2. Market Share & Forecast

8.3.4.2.1. By Type

8.3.4.2.2. By Dimension

8.3.4.2.3. By Supply Chain

8.3.5. Spain Semiconductor Manufacturing Back-End Equipment Market Outlook

8.3.5.1. Market Size & Forecast

8.3.5.1.1. By Value

8.3.5.2. Market Share & Forecast

8.3.5.2.1. By Type

8.3.5.2.2. By Dimension

8.3.5.2.3. By Supply Chain

9. ASIA-PACIFIC SEMICONDUCTOR MANUFACTURING BACK-END EQUIPMENT MARKET OUTLOOK

9.1. Market Size & Forecast

9.1.1. By Value

9.2. Market Share & Forecast

9.2.1. By Type

9.2.2. By Dimension

9.2.3. By Supply Chain

9.2.4. By Country

9.3. Asia-Pacific: Country Analysis

9.3.1. China Semiconductor Manufacturing Back-End Equipment Market Outlook

9.3.1.1. Market Size & Forecast

9.3.1.1.1. By Value

9.3.1.2. Market Share & Forecast

9.3.1.2.1. By Type

9.3.1.2.2. By Dimension

9.3.1.2.3. By Supply Chain

9.3.2. India Semiconductor Manufacturing Back-End Equipment Market Outlook

9.3.2.1. Market Size & Forecast

9.3.2.1.1. By Value

9.3.2.2. Market Share & Forecast

9.3.2.2.1. By Type

9.3.2.2.2. By Dimension

- 9.3.2.2.3. By Supply Chain
- 9.3.3. Japan Semiconductor Manufacturing Back-End Equipment Market Outlook
 - 9.3.3.1. Market Size & Forecast
 - 9.3.3.1.1. By Value
 - 9.3.3.2. Market Share & Forecast
 - 9.3.3.2.1. By Type
 - 9.3.3.2.2. By Dimension
 - 9.3.3.2.3. By Supply Chain
- 9.3.4. South Korea Semiconductor Manufacturing Back-End Equipment Market Outlook
 - 9.3.4.1. Market Size & Forecast
 - 9.3.4.1.1. By Value
 - 9.3.4.2. Market Share & Forecast
 - 9.3.4.2.1. By Type
 - 9.3.4.2.2. By Dimension
 - 9.3.4.2.3. By Supply Chain
- 9.3.5. Australia Semiconductor Manufacturing Back-End Equipment Market Outlook
 - 9.3.5.1. Market Size & Forecast
 - 9.3.5.1.1. By Value
 - 9.3.5.2. Market Share & Forecast
 - 9.3.5.2.1. By Type
 - 9.3.5.2.2. By Dimension
 - 9.3.5.2.3. By Supply Chain

10. SOUTH AMERICA SEMICONDUCTOR MANUFACTURING BACK-END EQUIPMENT MARKET OUTLOOK

- 10.1. Market Size & Forecast
 - 10.1.1. By Value
- 10.2. Market Share & Forecast
 - 10.2.1. By Type
 - 10.2.2. By Dimension
 - 10.2.3. By Supply Chain
 - 10.2.4. By Country
- 10.3. South America: Country Analysis
 - 10.3.1. Brazil Semiconductor Manufacturing Back-End Equipment Market Outlook
 - 10.3.1.1. Market Size & Forecast
 - 10.3.1.1.1. By Value
 - 10.3.1.2. Market Share & Forecast

- 10.3.1.2.1. By Type
- 10.3.1.2.2. By Dimension
- 10.3.1.2.3. By Supply Chain
- 10.3.2. Argentina Semiconductor Manufacturing Back-End Equipment Market Outlook
 - 10.3.2.1. Market Size & Forecast
 - 10.3.2.1.1. By Value
 - 10.3.2.2. Market Share & Forecast
 - 10.3.2.2.1. By Type
 - 10.3.2.2.2. By Dimension
 - 10.3.2.2.3. By Supply Chain
- 10.3.3. Colombia Semiconductor Manufacturing Back-End Equipment Market Outlook
 - 10.3.3.1. Market Size & Forecast
 - 10.3.3.1.1. By Value
 - 10.3.3.2. Market Share & Forecast
 - 10.3.3.2.1. By Type
 - 10.3.3.2.2. By Dimension
 - 10.3.3.2.3. By Supply Chain

11. MIDDLE EAST AND AFRICA SEMICONDUCTOR MANUFACTURING BACK-END EQUIPMENT MARKET OUTLOOK

- 11.1. Market Size & Forecast
 - 11.1.1. By Value
- 11.2. Market Share & Forecast
 - 11.2.1. By Type
 - 11.2.2. By Dimension
 - 11.2.3. By Supply Chain
 - 11.2.4. By Country
- 11.3. MEA: Country Analysis
 - 11.3.1. South Africa Semiconductor Manufacturing Back-End Equipment Market Outlook
 - 11.3.1.1. Market Size & Forecast
 - 11.3.1.1.1. By Value
 - 11.3.1.2. Market Share & Forecast
 - 11.3.1.2.1. By Type
 - 11.3.1.2.2. By Dimension
 - 11.3.1.2.3. By Supply Chain
 - 11.3.2. Saudi Arabia Semiconductor Manufacturing Back-End Equipment Market Outlook

- 11.3.2.1. Market Size & Forecast
 - 11.3.2.1.1. By Value
- 11.3.2.2. Market Share & Forecast
 - 11.3.2.2.1. By Type
 - 11.3.2.2.2. By Dimension
 - 11.3.2.2.3. By Supply Chain
- 11.3.3. UAE Semiconductor Manufacturing Back-End Equipment Market Outlook
 - 11.3.3.1. Market Size & Forecast
 - 11.3.3.1.1. By Value
 - 11.3.3.2. Market Share & Forecast
 - 11.3.3.2.1. By Type
 - 11.3.3.2.2. By Dimension
 - 11.3.3.2.3. By Supply Chain
- 11.3.4. Kuwait Semiconductor Manufacturing Back-End Equipment Market Outlook
 - 11.3.4.1. Market Size & Forecast
 - 11.3.4.1.1. By Value
 - 11.3.4.2. Market Share & Forecast
 - 11.3.4.2.1. By Type
 - 11.3.4.2.2. By Dimension
 - 11.3.4.2.3. By Supply Chain
- 11.3.5. Turkey Semiconductor Manufacturing Back-End Equipment Market Outlook
 - 11.3.5.1. Market Size & Forecast
 - 11.3.5.1.1. By Value
 - 11.3.5.2. Market Share & Forecast
 - 11.3.5.2.1. By Type
 - 11.3.5.2.2. By Dimension
 - 11.3.5.2.3. By Supply Chain
- 11.3.6. Egypt Semiconductor Manufacturing Back-End Equipment Market Outlook
 - 11.3.6.1. Market Size & Forecast
 - 11.3.6.1.1. By Value
 - 11.3.6.2. Market Share & Forecast
 - 11.3.6.2.1. By Type
 - 11.3.6.2.2. By Dimension
 - 11.3.6.2.3. By Supply Chain

12. MARKET DYNAMICS

12.1. Drivers

12.2. Challenges

13. MARKET TRENDS & DEVELOPMENTS

14. COMPANY PROFILES

14.1. Applied Materials, Inc. .

- 14.1.1. Business Overview
- 14.1.2. Key Revenue and Financials
- 14.1.3. Recent Developments
- 14.1.4. Key Personnel/Key Contact Person
- 14.1.5. Key Product/ Service Offered

14.2. Lam Research Corporation

- 14.2.1. Business Overview
- 14.2.2. Key Revenue and Financials
- 14.2.3. Recent Developments
- 14.2.4. Key Personnel/Key Contact Person
- 14.2.5. Key Product/ Service Offered

14.3. ASML Holding N.V.

- 14.3.1. Business Overview
- 14.3.2. Key Revenue and Financials
- 14.3.3. Recent Developments
- 14.3.4. Key Personnel/Key Contact Person
- 14.3.5. Key Product/ Service Offered

14.4. KLA Corporation

- 14.4.1. Business Overview
- 14.4.2. Key Revenue and Financials
- 14.4.3. Recent Developments
- 14.4.4. Key Personnel/Key Contact Person
- 14.4.5. Key Product/ Service Offered

14.5. Tokyo Electron Limited

- 14.5.1. Business Overview
- 14.5.2. Key Revenue and Financials
- 14.5.3. Recent Developments
- 14.5.4. Key Personnel/Key Contact Person
- 14.5.5. Key Product/ Service Offered

14.6. Ushio Inc.

- 14.6.1. Business Overview
- 14.6.2. Key Revenue and Financials

- 14.6.3. Recent Developments
- 14.6.4. Key Personnel/Key Contact Person
- 14.6.5. Key Product/ Service Offered
- 14.7. Advantest Corporation
 - 14.7.1. Business Overview
 - 14.7.2. Key Revenue and Financials
 - 14.7.3. Recent Developments
 - 14.7.4. Key Personnel/Key Contact Person
 - 14.7.5. Key Product/ Service Offered
- 14.8. SCREEN Semiconductor Solutions Co., Ltd. .
 - 14.8.1. Business Overview
 - 14.8.2. Key Revenue and Financials
 - 14.8.3. Recent Developments
 - 14.8.4. Key Personnel/Key Contact Person
 - 14.8.5. Key Product/ Service Offered
- 14.9. Nikon Corporation.
 - 14.9.1. Business Overview
 - 14.9.2. Key Revenue and Financials
 - 14.9.3. Recent Developments
 - 14.9.4. Key Personnel/Key Contact Person
 - 14.9.5. Key Product/ Service Offered
- 14.10. Hitachi High-Tech Corporation
 - 14.10.1. Business Overview
 - 14.10.2. Key Revenue and Financials
 - 14.10.3. Recent Developments
 - 14.10.4. Key Personnel/Key Contact Person
 - 14.10.5. Key Product/ Service Offered

15. STRATEGIC RECOMMENDATIONS

16. ABOUT US & DISCLAIMER

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